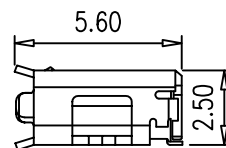


PCB Layout



Note:

1.Material:

- 1.1 Housing:LCP,UL94V-0.
- 1.2 Shell:BRASS.
- 1.3 Contact:PHOSPHOR BRONZE

2.FINISH:

- 2.1 CONTACT Plate with Gold Plate 15u"
- 2.2 shell:Nickel over all plating

3.Specification:

- 3.1 Dielectric withstanding voltage:100V(AC).
- 3.2 Contact resistance:50mΩ Max
- 3.3 Insulation resistance:100MΩ Min

USB-SW-10B-LF  
LEADFREE

RoHS Compliant

**MORETHANALL**  
CONNECTORS  
ASSEMBLIES

PART NO. MISB-SW-10B

DWG NO. MISB-SW-10B

CHECKED BY CY

TOLERANCES ARE

DESCRIP TION:

USB3.0 Micro B  
SMT TYPE

煜倫股份有限公司

FILE NO.

DRAWING BY

.X ± 0.2  
.XX ±  
.XXX ±  
AWG

AREA

REVISIONS

HK

DATE

UNIT / mm

SCALE 1:1

PROJECTION

